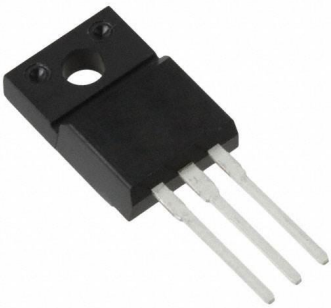


# 2SD12680P Datasheet

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<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	2SD12680P-DG
Manufacturer	<a href="#">Panasonic Electronic Components</a>
Manufacturer Product Number	2SD12680P
Description	TRANS NPN 80V 3A TO220F-A1
Detailed Description	Bipolar (BJT) Transistor NPN 80 V 3 A 30MHz 2 W Th rough Hole TO-220F-A1



Tel: +00 852-30501935

RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

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## Purchase and inquiry

Manufacturer Product Number:

2SD12680P

Series:

-

Transistor Type:

NPN

Voltage - Collector Emitter Breakdown (Max):

80 V

Current - Collector Cutoff (Max):

10 $\mu$ A (ICBO)

Power - Max:

2 W

Operating Temperature:

150°C (TJ)

Package / Case:

TO-220-3 Full Pack

Base Product Number:

2SD126

Manufacturer:

Panasonic Electronic Components

Product Status:

Obsolete

Current - Collector (Ic) (Max):

3 A

Vce Saturation (Max) @ Ib, Ic:

500mV @ 100mA, 2A

DC Current Gain (hFE) (Min) @ Ic, Vce:

130 @ 500mA, 2V

Frequency - Transition:

30MHz

Mounting Type:

Through Hole

Supplier Device Package:

TO-220F-A1

## Environmental & Export classification

Moisture Sensitivity Level (MSL):

1 (Unlimited)

HTSUS:

8541.29.0075

ECCN:

EAR99

# 2SD1268

## Silicon NPN epitaxial planar type

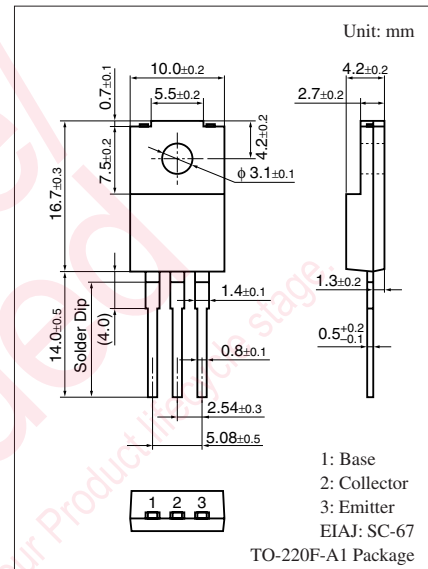
For power switching

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Satisfactory linearity of forward current transfer ratio  $h_{FE}$
- Large collector current  $I_C$
- Full-pack package which can be installed to the heat sink with one screw.

### ■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	130	V
Collector-emitter voltage (Base open)	$V_{CEO}$	80	V
Emitter-base voltage (Collector open)	$V_{EBO}$	7	V
Collector current	$I_C$	3	A
Peak collector current	$I_{CP}$	6	A
Collector power dissipation	$P_C$	30	W
	$T_a = 25^\circ\text{C}$	2.0	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$



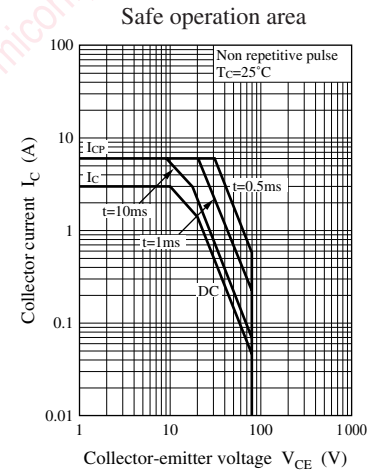
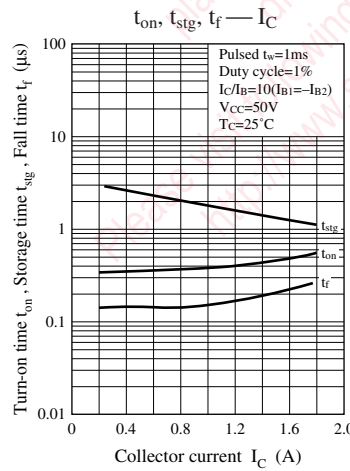
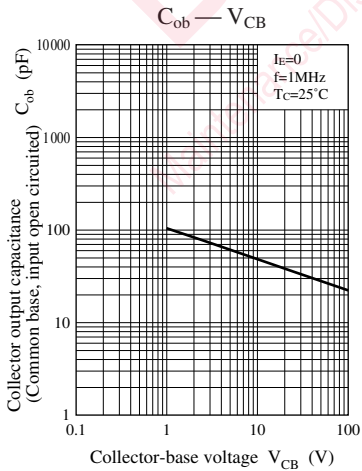
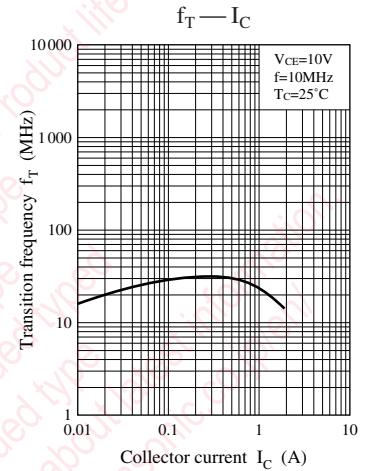
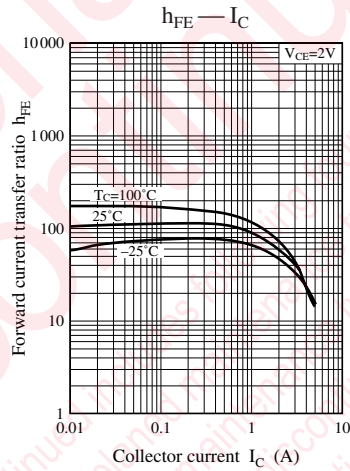
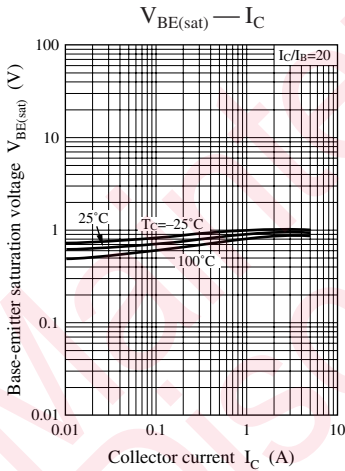
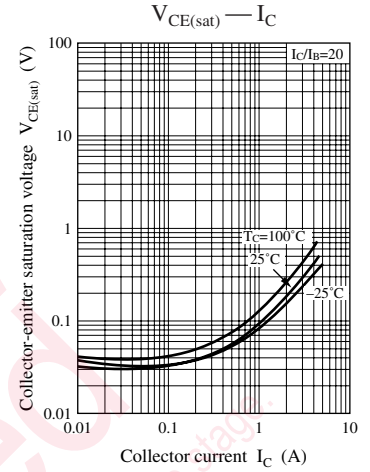
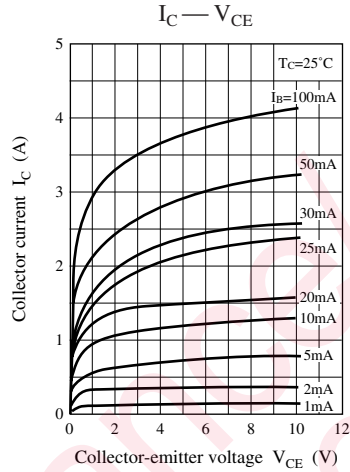
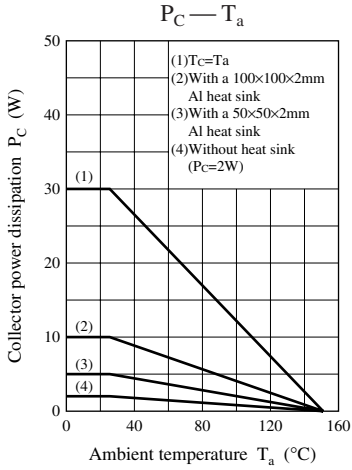
### ■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	$V_{CEO}$	$I_C = 10\text{ mA}, I_B = 0$	80			V
Collector-base cut-off current (Emitter open)	$I_{CBO}$	$V_{CB} = 100\text{ V}, I_E = 0$			10	$\mu\text{A}$
Emitter-base cut-off current (Collector open)	$I_{EBO}$	$V_{EB} = 5\text{ V}, I_C = 0$			50	$\mu\text{A}$
Forward current transfer ratio	$h_{FE1}$	$V_{CE} = 2\text{ V}, I_C = 0.1\text{ A}$	45			—
	$h_{FE2}^*$	$V_{CE} = 2\text{ V}, I_C = 0.5\text{ A}$	60		260	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 2\text{ A}, I_B = 0.1\text{ A}$			0.5	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 2\text{ A}, I_B = 0.1\text{ A}$			1.5	V
Transition frequency	$f_T$	$V_{CE} = 10\text{ V}, I_C = 0.5\text{ A}, f = 10\text{ MHz}$		30		MHz
Turn-on time	$t_{on}$	$I_C = 0.5\text{ A}, I_{B1} = 50\text{ mA}, I_{B2} = -50\text{ mA}$		0.5		$\mu\text{s}$
Storage time	$t_{stg}$	$V_{CC} = 50\text{ V}$		2.5		$\mu\text{s}$
Fall time	$t_f$			0.15		$\mu\text{s}$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	Q	P
$h_{FE2}$	60 to 120	90 to 180	130 to 260



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